A simple approach to assessing copper pitting corrosion tendencies and developing control strategies

Figure S1  Photograph of copper pitting corrosion evaluation pipe loop apparatus.

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Figure S2 | Scanning electron microscopy image through large pit identified in Figures 4(c) and 5a, b (after 101 days).
Figure S3 | Scanning electron microscopy image through small pit cap (Figure 4b) and corresponding elemental mapping by EDS of chlorine, sulfur, oxygen, and copper (after 101 days).
Figure S4 | Scanning electron microscopy image through large pit cap and corresponding elemental mapping by EDS of silicon, sulfur, chlorine, copper and oxygen (after 206 days).